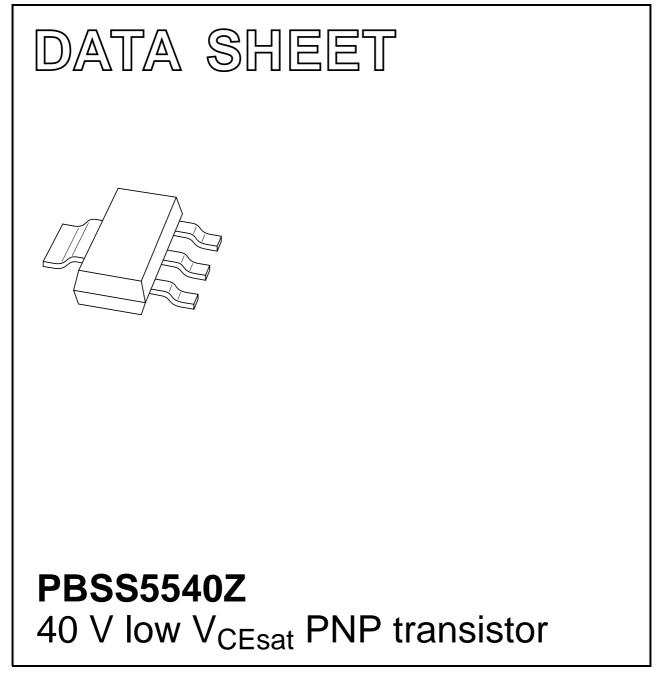
DISCRETE SEMICONDUCTORS



Product data sheet Supersedes data of 2001 Jan 26 2001 Sep 21



FEATURES

- Low collector-emitter saturation voltage
- High current capability
- Improved device reliability due to reduced heat generation.

APPLICATIONS

- Supply line switching circuits
- Battery management applications
- DC/DC converter applications
- Strobe flash units
- Heavy duty battery powered equipment (motor and lamp drivers)
- MOSFET driver applications.

DESCRIPTION

PNP low V_{CEsat} transistor in a SOT223 plastic package. NPN complement: PBSS4540Z.

MARKING

| TYPE NUMBER | MARKING CODE |
|-------------|--------------|
| PBSS5540Z | PB5540 |

QUICK REFERENCE DATA

| SYMBOL | PARAMETER | МАХ | UNIT | |
|--------------------|----------------------------|--------|------|--|
| V _{CEO} | emitter-collector voltage | -40 | V | |
| I _C | collector current (DC) | -5 | А | |
| I _{CM} | peak collector current -10 | | А | |
| R _{CEsat} | equivalent on-resistance | <80 mΩ | | |

PINNING

| PIN | DESCRIPTION | |
|-----|-------------|--|
| 1 | base | |
| 2 | collector | |
| 3 | emitter | |
| 4 | collector | |

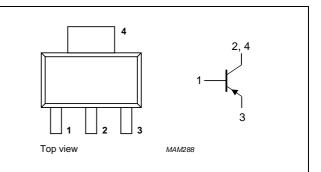


Fig.1 Simplified outline (SOT223) and symbol.

PBSS5540Z

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|-------------------------------|---------------------------------------|------|------|------|
| V _{CBO} | collector-base voltage | open emitter | - | -40 | V |
| V _{CEO} | collector-emitter voltage | open base | _ | -40 | V |
| V _{EBO} | emitter-base voltage | open collector | _ | -6 | V |
| I _C | collector current (DC) | | _ | -5 | А |
| I _{CM} | peak collector current | | _ | -10 | A |
| I _{BM} | peak base current | | _ | -2 | А |
| P _{tot} | total power dissipation | $T_{amb} \le 25 \ ^{\circ}C$; note 1 | _ | 1.35 | W |
| | | $T_{amb} \le 25 \ ^{\circ}C$; note 2 | _ | 2 | W |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| Tj | junction temperature | | _ | 150 | °C |
| T _{amb} | operating ambient temperature | | -65 | +150 | °C |

Notes

- 1. Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for collector 1 cm².
- 2. Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for collector 6 cm². For other mounting conditions, see *"Thermal considerations for SOT223 in the General Part of associated Handbook"*.

THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|---------------------|---|---------------------|-------|------|
| R _{th j-a} | thermal resistance from junction to ambient | in free air; note 1 | 92 | K/W |

Note

1. Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for collector 1 cm².

PBSS5540Z

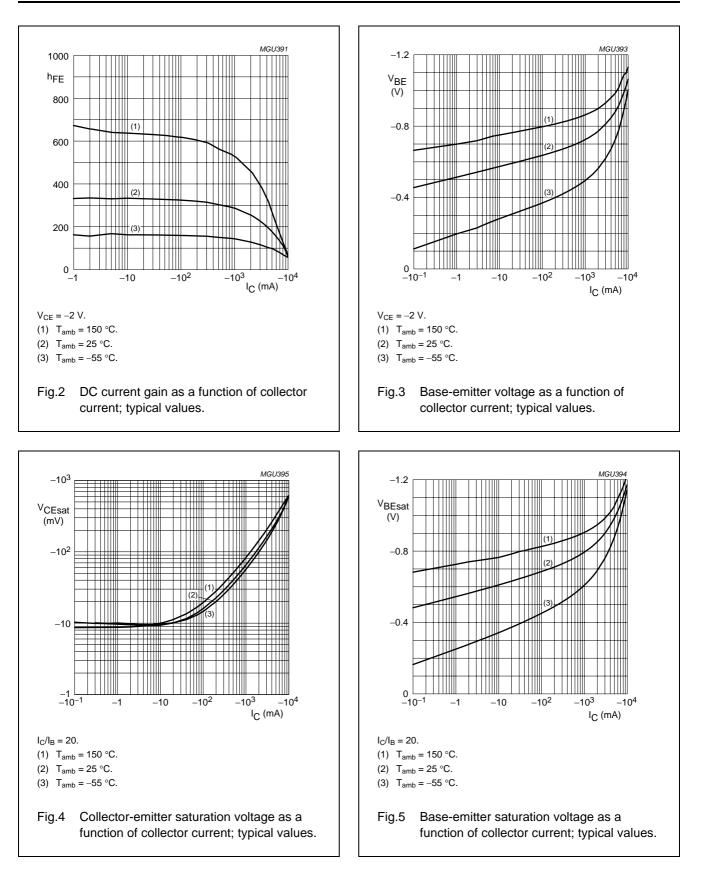
CHARACTERISTICS

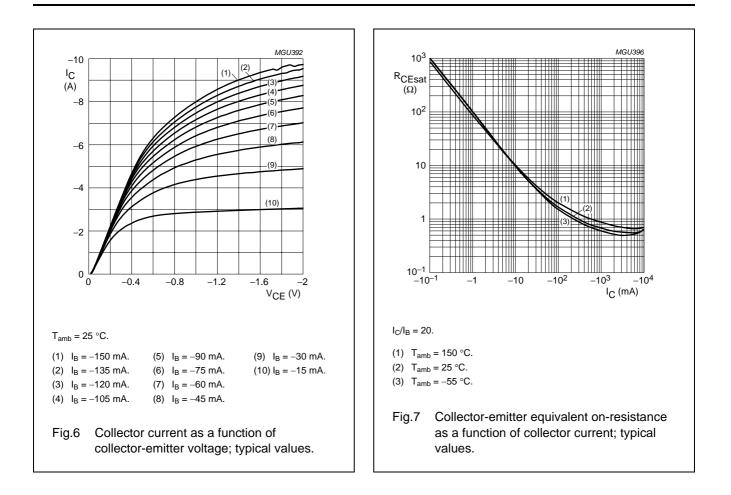
 T_{amb} = 25 °C unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|--------------------|--------------------------------------|---|------|------|-------|------|
| I _{CBO} | collector-base cut-off current | $V_{CB} = -30 \text{ V}; I_E = 0$ | _ | _ | -100 | nA |
| | | $V_{CB} = -30 \text{ V}; I_E = 0; T_j = 150 \text{ °C}$ | _ | _ | -50 | μA |
| I _{EBO} | emitter-base cut-off current | $V_{EB} = -5 V; I_C = 0$ | - | - | -100 | nA |
| h _{FE} | DC current gain | $V_{CE} = -2 \text{ V}; \text{ I}_{C} = -500 \text{ mA}$ | 250 | 350 | - | |
| | | $V_{CE} = -2 \text{ V}; I_{C} = -1 \text{ A}; \text{ note } 1$ | 200 | 300 | - | |
| | | $V_{CE} = -2 \text{ V}; \text{ I}_{C} = -2 \text{ A}; \text{ note } 1$ | 150 | 250 | - | |
| | | $V_{CE} = -2 \text{ V}; \text{ I}_{C} = -5 \text{ A}; \text{ note } 1$ | 50 | 150 | - | |
| V _{CEsat} | collector-emitter saturation voltage | $I_{C} = -500 \text{ mA}; I_{B} = -5 \text{ mA}$ | _ | -80 | -120 | mV |
| | | $I_{\rm C} = -1$ A; $I_{\rm B} = -10$ mA | - | -120 | -170 | mV |
| | | $I_{\rm C} = -2$ A; $I_{\rm B} = -200$ mA | - | -110 | -160 | mV |
| R _{CEsat} | equivalent on-resistance | $I_{C} = -2 \text{ A}; I_{B} = -200 \text{ mA}; \text{ note } 1$ | - | <55 | <80 | mΩ |
| V _{CEsat} | collector-emitter saturation voltage | $I_{C} = -5 \text{ A}; I_{B} = -500 \text{ mA}$ | - | -250 | -375 | mV |
| V _{BEsat} | base-emitter saturation voltage | $I_{C} = -5 \text{ A}; I_{B} = -500 \text{ mA}$ | - | - | -1.3 | V |
| V _{BEon} | base-emitter turn-on voltage | $V_{CE} = -2 V; I_C = -2 A$ | _ | -0.8 | -1.25 | V |
| f _T | transition frequency | $I_{C} = -100 \text{ mA}; V_{CE} = -10 \text{ V};$ f = 100 MHz | 60 | 120 | - | MHz |
| C _c | collector capacitance | $V_{CB} = -10 \text{ V}; \text{ I}_{E} = \text{ I}_{e} = 0;$ f = 1 MHz | - | 90 | 105 | pF |

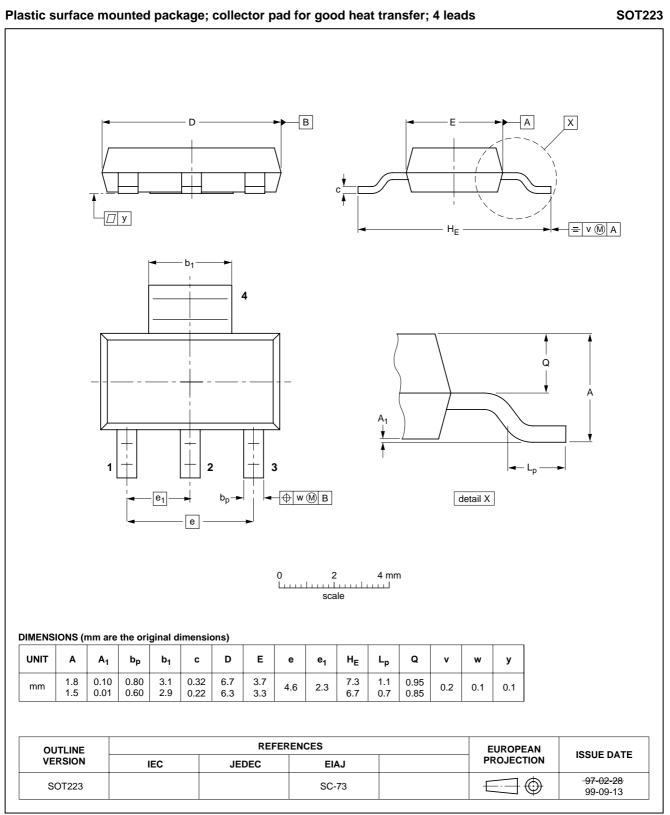
Note

1. Pulse test: $t_p \leq 300~\mu s;~\delta \leq 0.02.$





PACKAGE OUTLINE



PBSS5540Z

DATA SHEET STATUS

| DOCUMENT STATUS ⁽¹⁾ | PRODUCT STATUS ⁽²⁾ | DEFINITION |
|-----------------------------------|----------------------------------|---|
| Objective data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary data sheet | Qualification | This document contains data from the preliminary specification. |
| Product data sheet | Production | This document contains the product specification. |

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